



# CFR10XLB Series

1.0Amp. Fast Recovery Rectifiers

## Features

- Low forward voltage drop and low leakage current
- High current capability
- High surge current capability
- Plastic material used carries UL flammability classification 94V-0 utilizing flame retardant epoxy molding compound.
- High temperature soldering: 250°C/10 seconds at terminals
- High reliability

## Mechanical Data

- Case: DO-41 Molded Plastic.
- Terminals: Axial leads, solderable per MIL-STD-202, Method 208
- Polarity: Color band denotes cathode end.
- Mounting Position: Any
- Weight: 0.34 grams

## Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

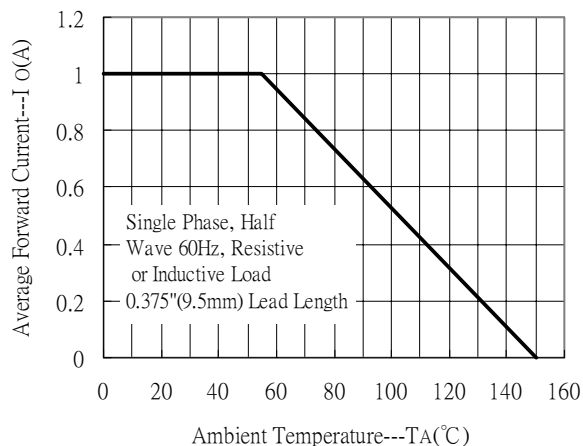
Type Number	CFR101	CFR102	CFR103	CFR104	CFR105	CFR106	CFR107	Units
Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current .375"(9.5mm) lead length at TA=75°C	1							A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load(JEDEC method)	30							A
Maximum Instantaneous Forward Voltage @ 1.0A	1.3							V
Maximum DC Reverse Current at Rated DC Blocking Voltage				5 (@Ta=25°C)				µA
				100 (@Ta=100°C)				
Typical Junction Capacitance (Note 1)	15							pF
Maximum Reverse Recovery Time(Note 2)	150				250	500		ns
Operating Temperature Range Tj	-65 to +150							°C
Storage Temperature Range Tstg	-65 to +150							°C

Notes : 1. Measured at 1 MHz and applied reverse voltage of 4.0Volts  
2 . Test Condition : IF=0.5A, IR=1A, IRR=0.25A.

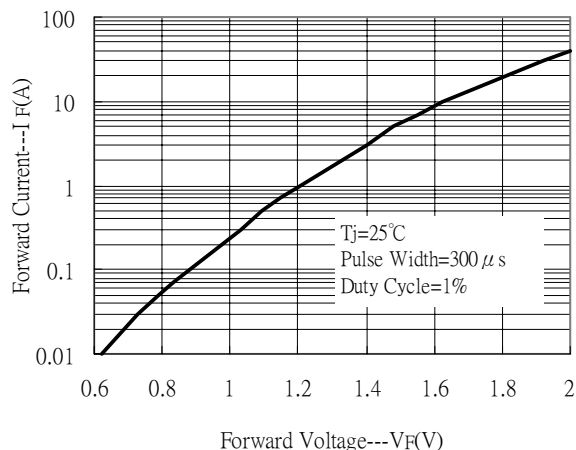


## Characteristic Curves

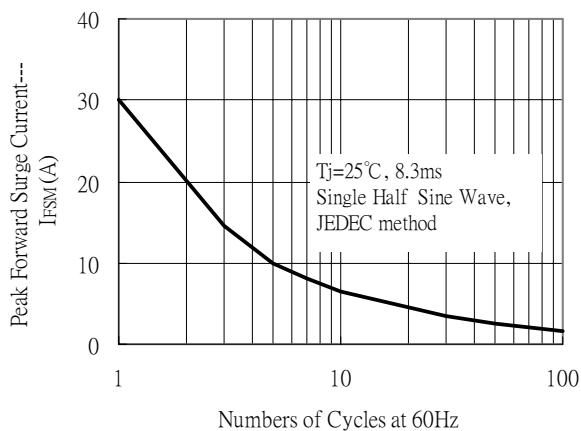
### Forward Current Derating Curve



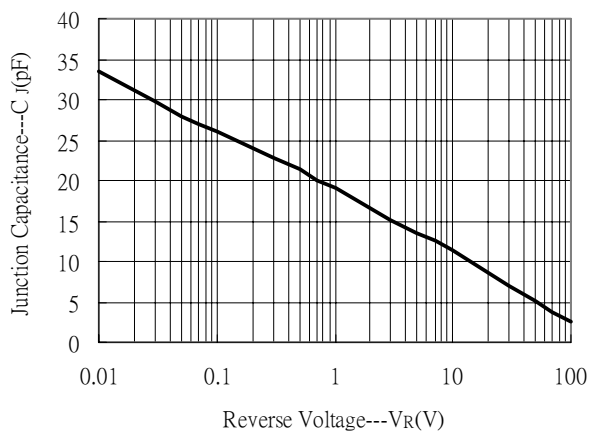
### Forward Current vs Forward Voltage



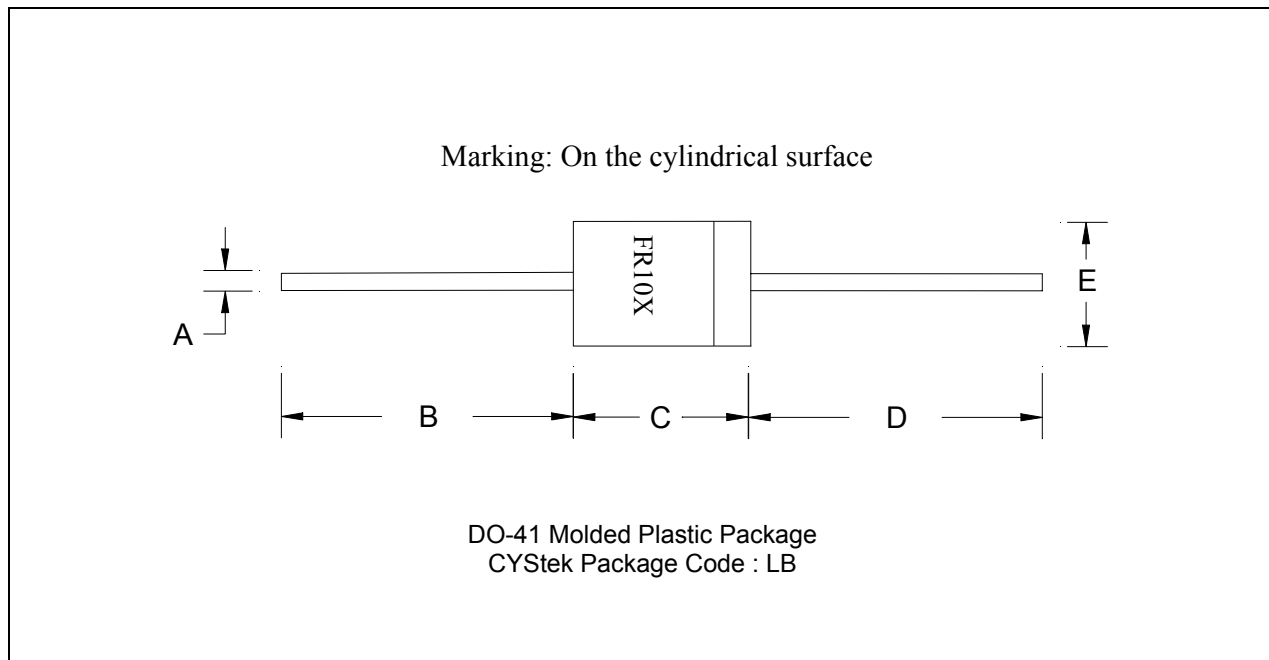
### Maximum Non-Repetitive Forward Surge Current



### Junction Capacitance vs Reverse Voltage



**DO-41 Dimension**



\*:Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.0280	0.0340	0.71	0.86	D	1.0000	-	25.40	-
B	1.0000	-	25.40	-	E	0.0800	0.1070	2.00	2.70
C	0.1600	0.2050	4.10	5.20					

**Notes :** 1. Controlling dimension : millimeters.  
 2. Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.  
 3. If there is any question with packing specification or packing method, please contact your local CYStek sales office.

**Material :**

- Lead : 42 Alloy ; solder plating
- Mold Compound : Epoxy resin family, flammability solid burning class:UL94V-0

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